506500745 02/11/2021

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TAKASHI MATSUMOTO	01/26/2021

RECEIVING PARTY DATA

Name:	SONY SEMICONDUCTOR SOLUTIONS CORPORATION
Street Address:	4-14-1 ASAHI-CHO, ATSUGI-SHI
City:	KANAGAWA
State/Country:	JAPAN
Postal Code:	243-0014

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17267944

CORRESPONDENCE DATA

Fax Number: (414)277-0656

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 414-271-6560

Email: DCipdocket@michaelbest.com

Correspondent Name: MICHAEL BEST & FRIEDRICH LLP (SONY)

Address Line 1: 790 N WATER ST Address Line 2: SUITE 2500

Address Line 4: MILWAUKEE, WISCONSIN 53202

ATTORNEY DOCKET NUMBER:	880005-6700-US01	
NAME OF SUBMITTER:	CHRISTOPHER M. TOBIN	
SIGNATURE:	/Christopher M. Tobin/	
DATE SIGNED: 02/11/2021		
	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 1

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PATENT 506500745 REEL: 055233 FRAME: 0205

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Title of Invention	DELTA-SIGMA MODULATOR AND METHOD OF DRIVING DELTA-SIGMA MODULATOR	
Docket Number	SYP328851US01	
As the below named in	ventor, I hereby declare that:	
This declaration is directed to:	The attached application, or	
	United States application or PCT international application number PCT/JP2019/036012 filed on 13 September 2019.	
The above-identified a	pplication was made or authorized to be made by me.	
I believe that I am the	original inventor or an original joint inventor of a claimed invention in the application.	
	that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine t more than five (5) years, or both.	
WHEREAS,	Sony Semiconductor Solutions Corporation	
hereinafter referred to	as "ASSIGNEE") having a place of business at:	
4-14-1 Asahicho, Atsug	-shi, Kanagawa, Japan	
desires to acquire the application;	entire right, title and interest in said invention and the above-identified United States patent	
acknowledged, I herel identified United State and reissues, extension in countries foreign to	EFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby by assign to the ASSIGNEE, the entire right, title and interest in said invention and in the aboves patent application and in all divisions, continuations and continuations-in-part of said application, as and renewals of Letters Patent granted thereon, and in all corresponding patent applications filed the United States ("foreign countries") and corresponding international patent applications, and in ing on any such patent applications in the United States and foreign countries;	
own name and the rig	in to the ASSIGNEE the right to file patent applications in foreign countries on said invention in its plat to claim priority to the above-identified United States patent application under the terms of the ion and any other relevant treaties;	
foreign countries to is interest in and to the	torize and request the United States Patent & Trademark Office and officials in patent offices in issue any and all of said Letters Patent to the ASSIGNEE as the assignee of my entire right, title and the same, for the sole use and behoof of the ASSIGNEE, its successors, assigns, and legal full end of the term for which said Letters Patent may be granted; and	
Further, I agree that, without further consideration, I will communicate to the ASSIGNEE any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, continuation-in-part, substitute, renewal and reissue applications, execute all necessary assignment papers to cause said Letters Patent to be issued to the ASSIGNEE, make all rightful oaths, and, perform all lawful acts to aid the ASSIGNEE, its successors and assigns, to obtain and enforce Letters Patent for said invention in the United States and foreign countries.		
LEGAL NAME OF	INVENTOR	
Inventor: TAKASHIA	латsuмото Date: 2021 / 1 / 26	
Signature: / TA	KASHI MATSUMOTO /	

RECORDED: 02/11/2021

PATENT REEL: 055233 FRAME: 0206